Schottky Barrier Rectifiers, Surface Mount, 1 A, 50 V - 150 V

SS15FA - S115FA

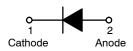
Features

- Low Power Loss, High Efficiency
- Guard Ring for Overvoltage Protection
- High Surge Current Capability
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- Green Molding Compound
- These Devices are Pb-Free and are RoHS Compliant



ON Semiconductor®

www.onsemi.com



Rectifier



SOD-123FL CASE 425AB

MARKING DIAGRAM



Band Indicates Cathode

&Y = Binary Calendar Year Coding Scheme

&Z = Assembly Plant Code

* = Specific Device Code

(see "Top Mark" in the table below)

&G = Single Digit Weekly Date Code

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]
SS15FA	15L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
SS16FA	16L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
SS19FA	19L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
S110FA	10L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
S115FA	1AL	SOD-123FL (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SS15FA - S115FA

SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

		Value					
Symbol	Parameter	SS15FA	SS16FA	SS19FA	S110FA	S115FA	Unit
V _{RRM}	Repetitive Peak Reverse Voltage	50	60	90	100	150	V
V _{RMS}	RMS Reverse Voltage	35	42	63	70	105	V
V _R	DC Blocking Voltage	50	60	90	100	150	V
I _{F(AV)}	Average Forward Rectified Current	1		Α			
I _{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine– Wave Superimposed on Rated Load	30		Α			
TJ	Operating Junction Temperature Range	-55 to +150		°C			
T _{STG}	Storage Temperature Range	-55 to +150		°C			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Note 1)

Symbol	Characteristic	Value	Unit
Ψ_{JL}	Junction-to-Lead Thermal Characteristics	16	°C/W
$R_{ hetaJA}$	Junction-to-Ambient Thermal Resistance	152	°C/W

^{1.} Per JESD51-3 Recommended Thermal Test Board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

			Value					
Symbol	Parameter	Conditions	SS15FA	SS16FA	SS19FA	S110FA	S115FA	Unit
V _F	Maximum Instantaneous Forward Voltage	I _F = 0.5 A	0.58		0.70 0.75		0.75	V
	(Note 2)	I _F = 1.0 A	0.70		0.80		0.90	
-11	Maximum Reverse Current at Rated V _R	T _J = 25°C	0.4		0.05			mA
		T _J = 100°C	6.0		_			
		T _J = 125°C	-		0.5			
СЈ	Typical Junction Capacitance	V _R = 4 V, f = 1 MHz	54		54 35			pF
T _{rr}	Typical Reverse Recovery Time	I _F = 0.5 A, I _R = 1 A, I _{RR} = 0.25 A	5.6 8.3			ns		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse test with PW = 300 μ s, 1% duty cycle.

SS15FA - S115FA

TYPICAL PERFORMANCE CHARACTERISTICS

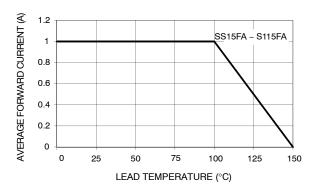


Figure 1. Forward Current Derating Curve



Figure 2. Maximum Non-Repetitive Forward Surge Current

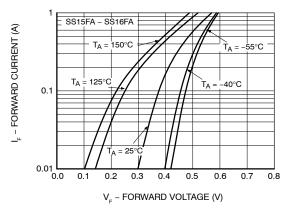


Figure 3. Typical Forward Characteristics

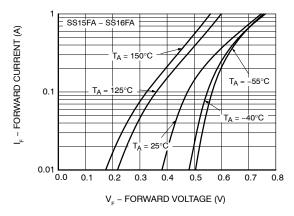


Figure 4. Typical Forward Characteristics

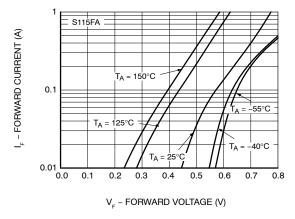


Figure 5. Typical Forward Characteristics

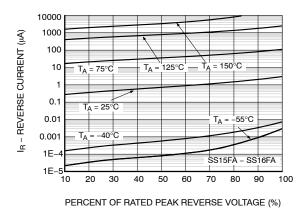


Figure 6. Typical Reverse Characteristics

SS15FA - S115FA

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

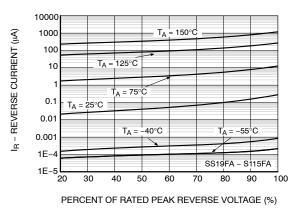


Figure 7. Typical Reverse Characteristics

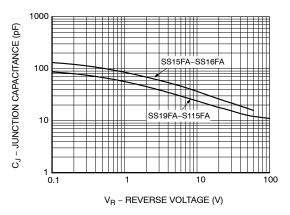
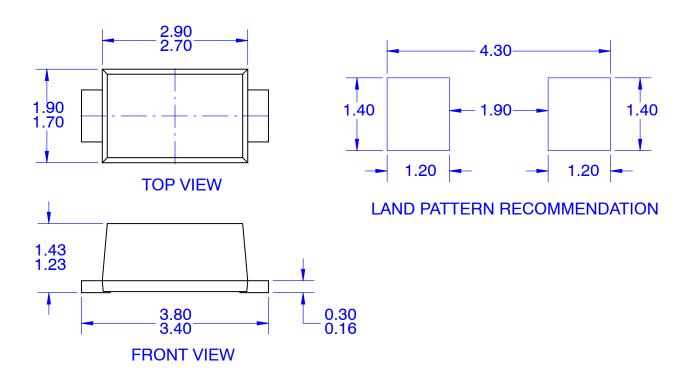


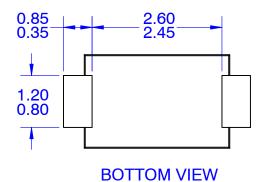
Figure 8. Typical Junction Capacitance



SOD-123FL CASE 425AB ISSUE O

DATE 31 AUG 2016





NOTES:

A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.

B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

DOCUMENT NUMBER:	98AON13722G	Electronic versions are uncontrolled except when accessed directly from the Document Repos Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
DESCRIPTION:	SOD-123FL		PAGE 1 OF 1			

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

ON Semiconductor and the are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor and see no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative